



Express Mail Label No.: None

Applicant: Iver E. ANDERSON, et al
 Ser.No. : 08/094 854 Filed : July 20, 1993
 Group : Unknown Atty.Ref.: ISU Case 340

U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
JOK	AA 4 248 905	02/1981	Harvey	427	11	01/1980
JOK	AB 4 670 217	06/1987	Henson, et al	420	562	07/1985
JOK	AC 4 695 428	09/1987	Ballentine, et al	420	561	08/1986
JOK	AD 4 758 407	07/1988	Ballentine, et al	420	560	06/1987
JOK	AE 4 778 733	10/1988	Lubrano, et al	428	647	07/1986
JOK	AF 4 879 096	11/1989/	Naton	420	561	04/1989
AG						
AH						
AI						
AJ						
AK						

FOREIGN PATENT DOCUMENTS

Document Number	Date	Country	Class	Sub Class	Translation Yes	Translation No
AL						
AM						
AN						
AO						
AP						

OTHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.)

JOK	AR	"Über den Aufbau des systems Silber-Kupfer-Zinn" Z. Metallkunde Bd. 50 (1959) H.10, p. 597
JOK	AS	"Developing Lead-Free Solders: A Challenge and Opportunity" JOM, Vol. 45, No. 7, July 1993, pgs. 1 and 13; Sungho Jin

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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.